

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT												
NATURE OF CONVEYANCE:	ASSIGNMENT												
CONVEYING PARTY DATA													
<table border="1"> <thead> <tr> <th>Name</th> <th>Execution Date</th> </tr> </thead> <tbody> <tr> <td>Akinori Shiraishi</td> <td>10/14/2008</td> </tr> <tr> <td>Kei Murayama</td> <td>10/14/2008</td> </tr> <tr> <td>Yuichi Taguchi</td> <td>10/14/2008</td> </tr> <tr> <td>Masahiro Sunohara</td> <td>10/14/2008</td> </tr> <tr> <td>Mitsutoshi Higashi</td> <td>10/14/2008</td> </tr> </tbody> </table>		Name	Execution Date	Akinori Shiraishi	10/14/2008	Kei Murayama	10/14/2008	Yuichi Taguchi	10/14/2008	Masahiro Sunohara	10/14/2008	Mitsutoshi Higashi	10/14/2008
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RECEIVING PARTY DATA													
Name:	SHINKO ELECTRIC INDUSTRIES CO., LTD.												
Street Address:	80, Oshimada-machi												
City:	Nagano-shi, Nagano												
State/Country:	JAPAN												
Postal Code:	381-2287												
PROPERTY NUMBERS Total: 1													
<table border="1"> <thead> <tr> <th>Property Type</th> <th>Number</th> </tr> </thead> <tbody> <tr> <td>Application Number:</td> <td>13116623</td> </tr> </tbody> </table>		Property Type	Number	Application Number:	13116623								
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CORRESPONDENCE DATA													
Fax Number:	(216)566-9711												
<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>													
Phone:	2165669700												
Email:	almasy@rankinhill.com												
Correspondent Name:	Rankin Hill and Clark LLP												
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Address Line 4:	Willoughby, OHIO 44094												
ATTORNEY DOCKET NUMBER:	HKY-18652.01												
NAME OF SUBMITTER:	David E. Spaw												
Total Attachments: 3 source=18652#page1.tif source=18652#page2.tif source=18652#page3.tif													

CH \$40.00 13116623

L. Rankin Hill
10/24/2008

ASSIGNMENT

WHEREAS, new and useful improvements have been made by the undersigned
in
SILICON SUBSTRATE FOR PACKAGE

that are the subject of an application for a U.S. Patent, (Application No. 12/257626
, filed 10/24/2008), which application is further identified as Rankin, Hill &
Clark LLP Docket No. HKY-18652.

WHEREAS, SHINKO ELECTRIC INDUSTRIES CO., LTD., a corporation of
Japan, and having a place of business at 80, Oshimada-machi, Nagano-shi, Nagano
381-2287, Japan, hereinafter referred to as "assignee", is desirous of acquiring all
right, title, and interest throughout the world in, to, and under said improvements and
inventions and patent rights therefor.

NOW, THEREFORE, be it known that, for valuable consideration, the receipt
and sufficiency of which are hereby acknowledged, all right, title, and interest, in the
United States and throughout the world, in, to and under said improvements and
inventions and all patents, patent applications, patent rights, and inventor's certificates
thereof, therefor, and therein, including without limitation said application for patent in
the United States, all divisions and continuations thereof, all patents which may be
granted thereon, all reissues and extensions thereof, all right to sue for past
infringement thereunder, all patents which may be granted for said improvements and
inventions by states or nations other than the United States, or by other authority,
entity, or organization, and all applications therefor, have been and are hereby sold,
assigned, transferred, and delivered unto assignee, its successors and assigns; and it
is covenanted and agreed by the undersigned, and for executors, administrators, and
legal representatives of the undersigned, that at assignee's request any and all
applications, affidavits, assignments, and other instruments will be made, executed,
and delivered as may be necessary, or desirable to secure for or vest in assignee, its
successors or assigns, any improvement, inventions, right, title, interest, application,
patent, patent right or other right or property covered by this assignment, and the
United States Commissioner of Patents and Trademarks is hereby requested and
authorized to issue any and all United States patents granted on any of said
applications to assignee as owner of the entire right, title, and interest in, to, and under
the same, and appropriately empowered officials of foreign countries are hereby
authorized to issue any letters patent granted on any of said applications to assignee
as owner of the entire right, title and interest in, to, and under the same.

The undersigned hereby grants the firm of Rankin, Hill & Clark LLP the power to
insert on this assignment any identification that may be necessary or desirable in order
to comply with the rules of the United States Patent and Trademark Office for
recording of this document.

IN WITNESS WHEREOF, this assignment has been executed below by the undersigned:

(1) Inventor Name (sole or joint): Akinori SHIRAISHI
Signature: Akinori Shiraishi
Today's Date : October 14, 2008

Witness: _____

Witness: _____

(2) Inventor Name (joint): Kei MURAYAMA
Signature: Kei Murayama
Today's Date : October 14, 2008

Witness: _____

Witness: _____

(3) Inventor Name (joint): Yuichi TAGUCHI
Signature: Yuichi Taguchi
Today's Date : October 14, 2008

Witness: _____

Witness: _____

(4) Inventor Name (joint): Masahiro SUNOHARA
Signature: Masahiro Sunohara
Today's Date : October 14, 2008

Witness: _____

Witness: _____

(5) Inventor Name (joint): Mitsutoshi HIGASHI
Signature: Mitsutoshi Higashi
Today's Date : October 14, 2008

Witness: _____

Witness: _____

(6) Inventor Name (joint): _____
Signature: _____
Today's Date : _____

Witness: _____

Witness: _____